

EconoPACK™3 module with Trench/Fieldstop IGBT4 and Emitter Controlled diode and NTC

Features

- Electrical features
 - $V_{CES} = 1700 \text{ V}$
 - $I_{C\text{ nom}} = 100 \text{ A} / I_{CRM} = 200 \text{ A}$
 - Low V_{CEsat}
 - $T_{vj\text{ op}} = 150^\circ\text{C}$
 - Trench IGBT 4
 - V_{CEsat} with positive temperature coefficient
- Mechanical features
 - Integrated NTC temperature sensor
 - Standard housing
 - Solder contact technology
 - Isolated base plate



Typical appearance

Potential applications

- High power converters
- Medium voltage converters

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

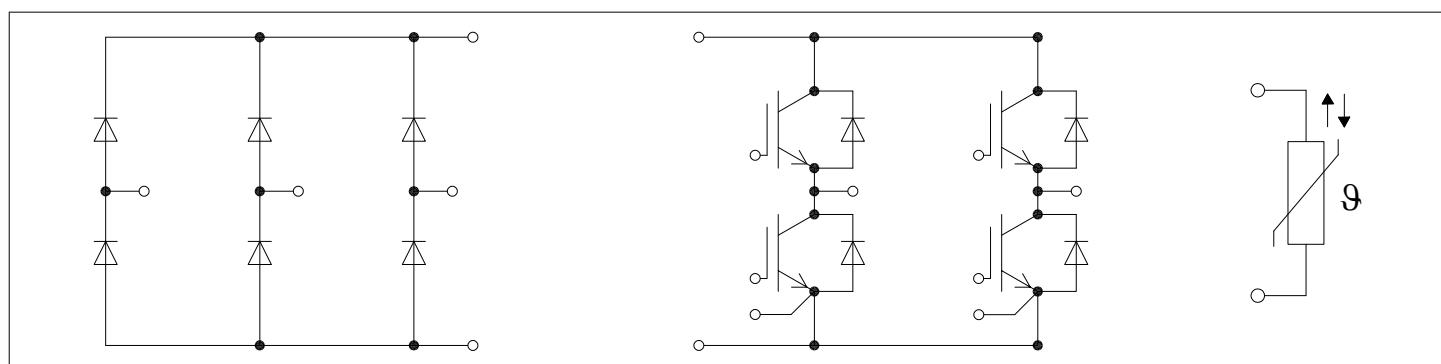


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1 Package

1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	3.4	kV
Material of module baseplate			Cu	
Internal Isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	d_{Creep}	terminal to heatsink	10.0	mm
Clearance	d_{Clear}	terminal to heatsink	7.5	mm
Comparative tracking index	CTI		> 225	
RTI Elec.	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{sCE}			33		nH
Module lead resistance, terminals - chip	$R_{AA'+CC'}$	$T_C = 25^\circ\text{C}$, per switch		4		mΩ
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_C = 25^\circ\text{C}$, per switch		3		mΩ
Storage temperature	T_{stg}		-40		125	°C
Mounting torque for modul mounting	M	- Mounting according to valid application note	M5, Screw	3	6	Nm
Weight	G			300		g

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
Collector-emitter voltage	V_{CES}	$T_{vj} = 25^\circ\text{C}$	1700	V	
Continous DC collector current	I_{CDC}	$T_{vj \max} = 175^\circ\text{C}$	$T_C = 95^\circ\text{C}$	100	A
Repetitive peak collector current	I_{CRM}	$t_P = 1 \text{ ms}$		200	A
Gate-emitter peak voltage	V_{GES}		± 20	V	

Table 4 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\text{ sat}}$	$I_C = 100 \text{ A}$, $V_{GE} = 15 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		1.90	2.25
			$T_{vj} = 125^\circ\text{C}$		2.30	
			$T_{vj} = 150^\circ\text{C}$		2.40	
Gate threshold voltage	$V_{GE\text{th}}$	$I_C = 4 \text{ mA}$, $V_{CE} = V_{GE}$, $T_{vj} = 25^\circ\text{C}$		5.35	5.80	6.25
Gate charge	Q_G	$V_{GE} = \pm 15 \text{ V}$			1.2	
Internal gate resistor	$R_{G\text{int}}$	$T_{vj} = 25^\circ\text{C}$			7.5	
Input capacitance	C_{ies}	$f = 1000 \text{ kHz}$, $T_{vj} = 25^\circ\text{C}$, $V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$			9	
Reverse transfer capacitance	C_{res}	$f = 1000 \text{ kHz}$, $T_{vj} = 25^\circ\text{C}$, $V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$			0.29	
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 1700 \text{ V}$, $V_{GE} = 0 \text{ V}$	$T_{vj} = 25^\circ\text{C}$			1 mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0 \text{ V}$, $V_{GE} = 20 \text{ V}$, $T_{vj} = 25^\circ\text{C}$			400 nA	
Turn-on delay time (inductive load)	t_{don}	$I_C = 100 \text{ A}$, $V_{CE} = 900 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Gon} = 0.91 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.191	
			$T_{vj} = 125^\circ\text{C}$		0.213	
			$T_{vj} = 150^\circ\text{C}$		0.218	
Rise time (inductive load)	t_r	$I_C = 100 \text{ A}$, $V_{CE} = 900 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Gon} = 0.91 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.052	
			$T_{vj} = 125^\circ\text{C}$		0.056	
			$T_{vj} = 150^\circ\text{C}$		0.058	
Turn-off delay time (inductive load)	t_{doff}	$I_C = 100 \text{ A}$, $V_{CE} = 900 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Goff} = 0.91 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.409	
			$T_{vj} = 125^\circ\text{C}$		0.562	
			$T_{vj} = 150^\circ\text{C}$		0.599	
Fall time (inductive load)	t_f	$I_C = 100 \text{ A}$, $V_{CE} = 900 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Goff} = 0.91 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.289	
			$T_{vj} = 125^\circ\text{C}$		0.507	
			$T_{vj} = 150^\circ\text{C}$		0.556	
Turn-on energy loss per pulse	E_{on}	$I_C = 100 \text{ A}$, $V_{CE} = 900 \text{ V}$, $L_\sigma = 35 \text{ nH}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Gon} = 0.91 \Omega$, $di/dt = 1050 \text{ A}/\mu\text{s}$ ($T_{vj} = 150^\circ\text{C}$)	$T_{vj} = 25^\circ\text{C}$		27.9	
			$T_{vj} = 125^\circ\text{C}$		38.2	
			$T_{vj} = 150^\circ\text{C}$		40.9	
Turn-off energy loss per pulse	E_{off}	$I_C = 100 \text{ A}$, $V_{CE} = 900 \text{ V}$, $L_\sigma = 35 \text{ nH}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Goff} = 0.91 \Omega$, $dv/dt = 3050 \text{ V}/\mu\text{s}$ ($T_{vj} = 150^\circ\text{C}$)	$T_{vj} = 25^\circ\text{C}$		19	
			$T_{vj} = 125^\circ\text{C}$		31.1	
			$T_{vj} = 150^\circ\text{C}$		34.9	
SC data	I_{SC}	$V_{GE} \leq 15 \text{ V}$, $V_{CC} = 1000 \text{ V}$, $V_{CE\text{max}} = V_{CES} - L_{sCE} * di/dt$	$t_P \leq 10 \mu\text{s}$, $T_{vj} = 150^\circ\text{C}$		460	A
Thermal resistance, junction to case	R_{thJC}	per IGBT			0.267	K/W

3 Diode, Inverter

Table 4 Characteristic values (continued)

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, case to heatsink	R_{thCH}	per IGBT, $\lambda_{grease} = 1 \text{ W}/(\text{m}^*\text{K})$		0.0680		K/W
Temperature under switching conditions	$T_{vj op}$		-40		150	°C

3 Diode, Inverter

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition	Values			Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25 \text{ °C}$	1700		V
Continous DC forward current	I_F			100		A
Repetitive peak forward current	I_{FRM}	$t_P = 1 \text{ ms}$		200		A
I^2t - value	I^2t	$t_P = 10 \text{ ms}, V_R = 0 \text{ V}$	$T_{vj} = 125 \text{ °C}$	1130		A^2s
			$T_{vj} = 150 \text{ °C}$	1100		

Table 6 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 100 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ °C}$		1.80	V
			$T_{vj} = 125 \text{ °C}$		1.90	
			$T_{vj} = 150 \text{ °C}$		1.95	
Peak reverse recovery current	I_{RM}	$V_R = 900 \text{ V}, I_F = 100 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 1050 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$		71.4	A
			$T_{vj} = 125 \text{ °C}$		77.9	
			$T_{vj} = 150 \text{ °C}$		79.9	
Recovered charge	Q_r	$V_R = 900 \text{ V}, I_F = 100 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 1050 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$		23.2	μC
			$T_{vj} = 125 \text{ °C}$		40.5	
			$T_{vj} = 150 \text{ °C}$		46.1	
Reverse recovery energy	E_{rec}	$V_R = 900 \text{ V}, I_F = 100 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 1050 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$		11.9	mJ
			$T_{vj} = 125 \text{ °C}$		22.8	
			$T_{vj} = 150 \text{ °C}$		26.4	
Thermal resistance, junction to case	R_{thJC}	per diode			0.465	K/W

4 Diode, Rectifier

Table 6 Characteristic values (continued)

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, case to heatsink	R_{thCH}	per diode, $\lambda_{grease} = 1 \text{ W}/(\text{m}^*\text{K})$		0.0700		K/W
Temperature under switching conditions	$T_{vj, op}$		-40		150	°C

4 Diode, Rectifier

Table 7 Maximum rated values

Parameter	Symbol	Note or test condition	Values			Unit
Repetitive peak reverse voltage	V_{RRM}		1800			V
Maximum RMS forward current per chip	I_{FRMSM}	$T_C = 80 \text{ °C}$	100			A
Maximum RMS current at rectifier output	I_{RMSM}	$T_C = 80 \text{ °C}$	150			A
Surge forward current	I_{FSM}	$t_P = 10 \text{ ms}$	$T_{vj} = 25 \text{ °C}$	829		A
			$T_{vj} = 150 \text{ °C}$	705		
I^2t - value	I^2t	$t_P = 10 \text{ ms}$	$T_{vj} = 25 \text{ °C}$	3440		A^2s
			$T_{vj} = 150 \text{ °C}$	2490		

Table 8 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$T_{vj} = 150 \text{ °C}, I_F = 150 \text{ A}$		1.15		V
Threshold voltage	$V_{(TO)}$	$T_{vj} = 150 \text{ °C}$		0.78		V
Slope resistance	r_t	$T_{vj} = 150 \text{ °C}$		2.4		$\text{m}\Omega$
Reverse current	I_r	$T_{vj} = 150 \text{ °C}, V_R = 1800 \text{ V}$		1		mA
Thermal resistance, junction to case	R_{thJC}	per diode			0.552	K/W
Thermal resistance, case to heatsink	R_{thCH}	per diode, $\lambda_{Paste} = 1 \text{ W}/(\text{m}^*\text{K}) / \lambda_{grease} = 1 \text{ W}/(\text{m}^*\text{K})$		0.0740		K/W
Temperature under switching conditions	$T_{vj, op}$		-40		150	°C

5 NTC-Thermistor

5 NTC-Thermistor

Table 9 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25 \text{ }^{\circ}\text{C}$		5		$\text{k}\Omega$
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100 \text{ }^{\circ}\text{C}, R_{100} = 493 \Omega$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25 \text{ }^{\circ}\text{C}$		20		mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$		3433		K

Note: Specification according to the valid application note.

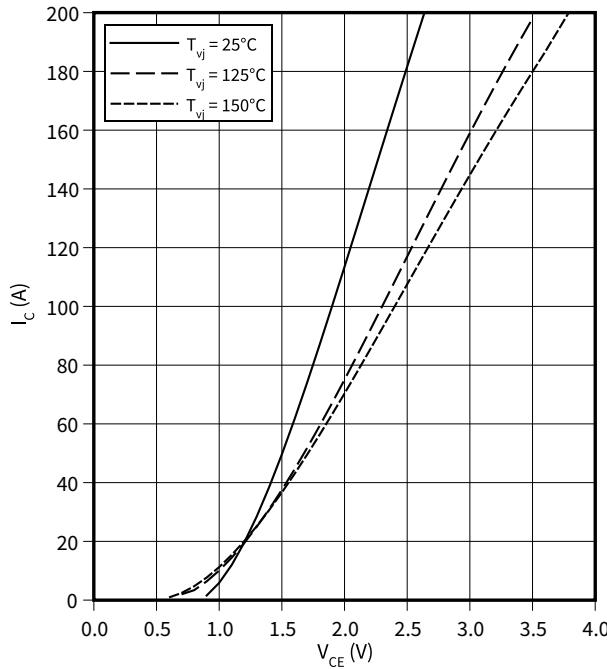
6 Characteristics diagrams

6 Characteristics diagrams

output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$

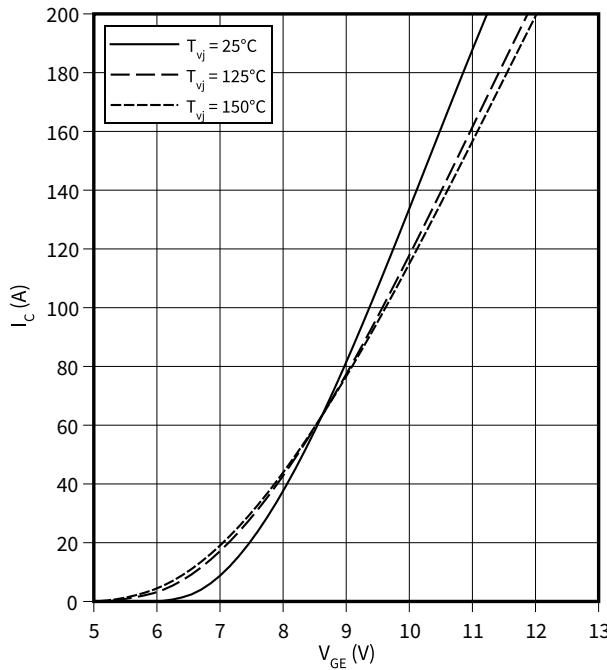
$V_{GE} = 15 \text{ V}$



transfer characteristic (typical), IGBT, Inverter

$I_C = f(V_{GE})$

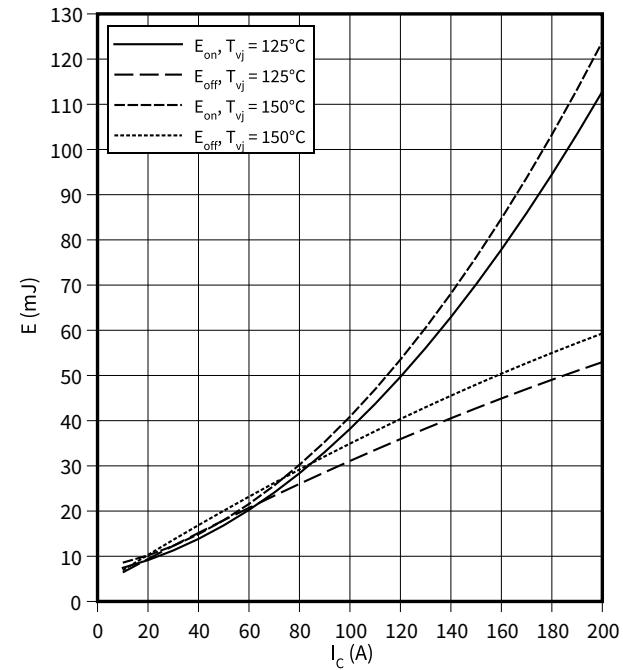
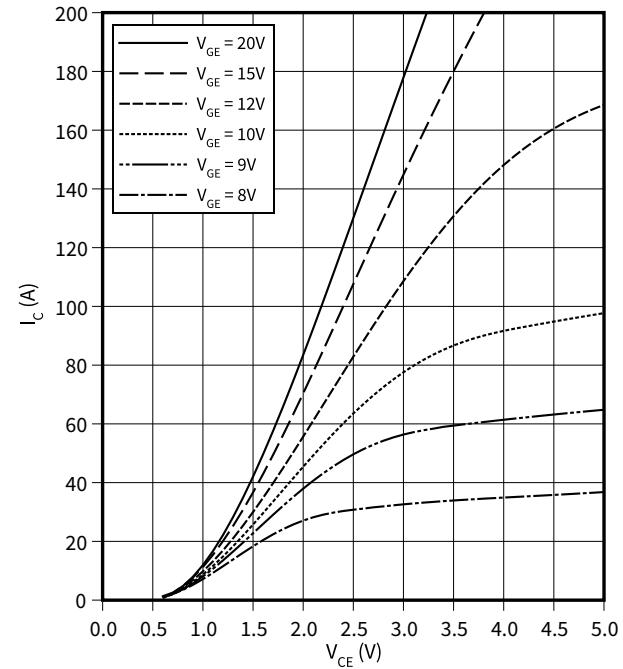
$V_{CE} = 20 \text{ V}$



switching losses (typical), IGBT, Inverter

$E = f(I_C)$

$R_{Goff} = 0.91 \Omega$, $R_{Gon} = 0.91 \Omega$, $V_{CE} = 900 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$

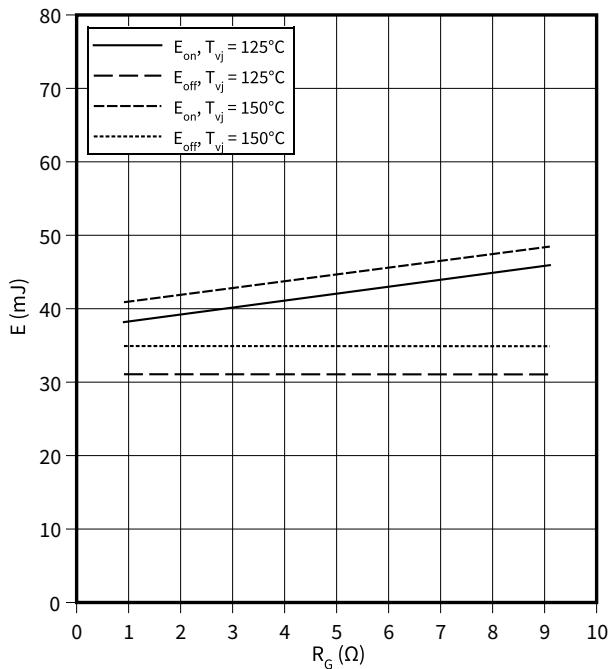


6 Characteristics diagrams

switching losses (typical), IGBT, Inverter

$$E = f(R_G)$$

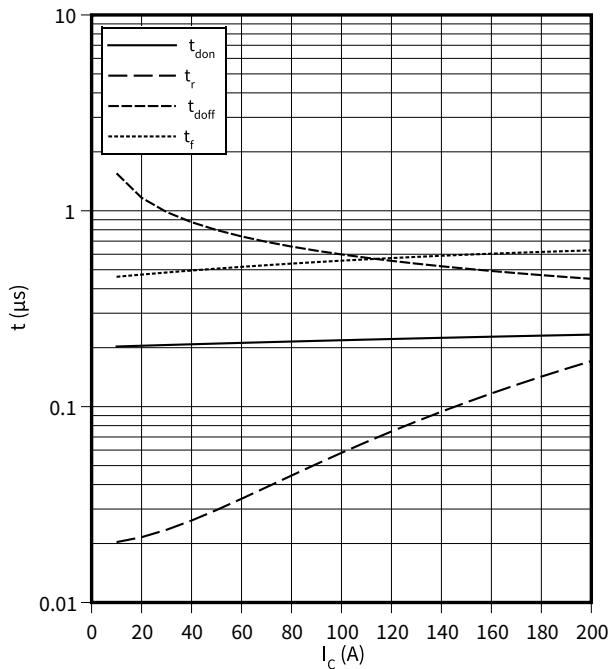
$I_C = 100 \text{ A}$, $V_{CE} = 900 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$



switching times (typical), IGBT, Inverter

$$t = f(I_C)$$

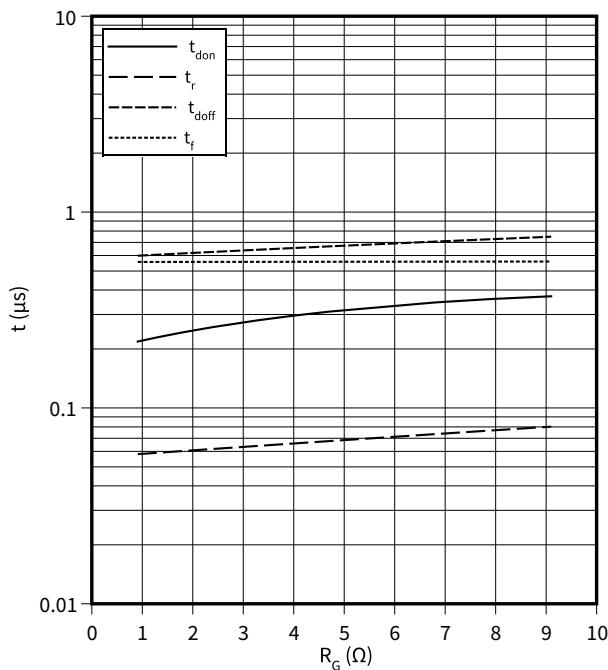
$R_{Goff} = 0.91 \Omega$, $R_{Gon} = 0.91 \Omega$, $V_{CE} = 900 \text{ V}$, $V_{GE} = -15 / 15 \text{ V}$, $T_{vj} = 150^\circ\text{C}$



switching times (typical), IGBT, Inverter

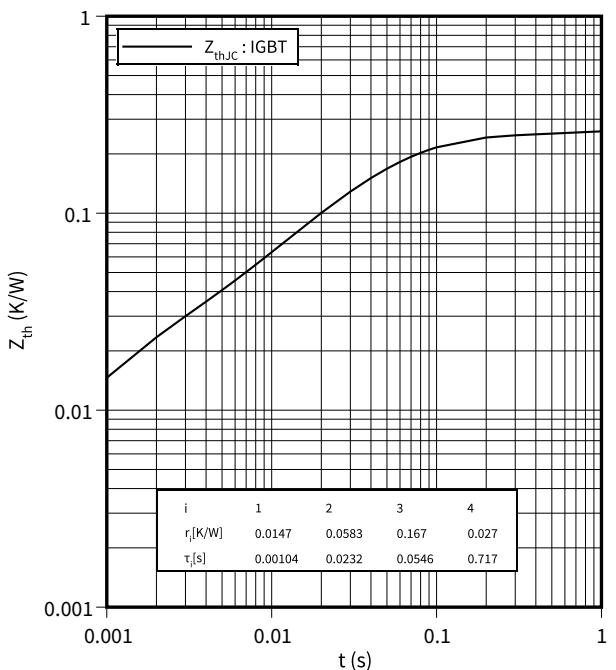
$$t = f(R_G)$$

$I_C = 100 \text{ A}$, $V_{CE} = 900 \text{ V}$, $V_{GE} = -15 / 15 \text{ V}$, $T_{vj} = 150^\circ\text{C}$



transient thermal impedance , IGBT, Inverter

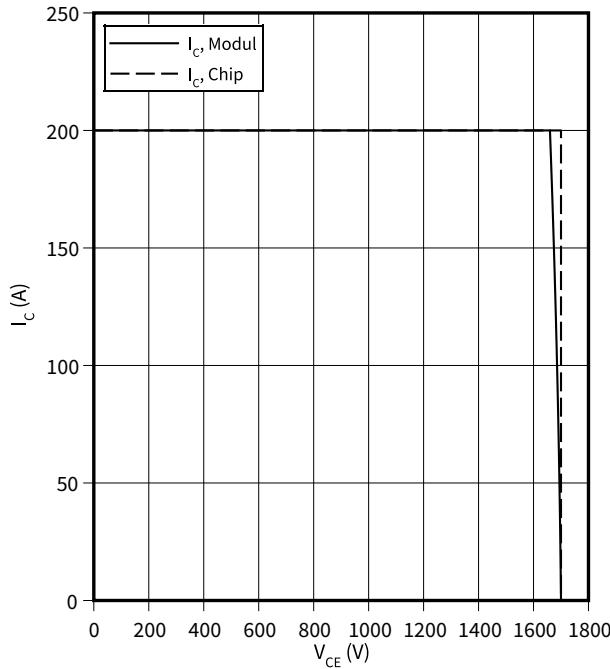
$$Z_{th} = f(t)$$



6 Characteristics diagrams

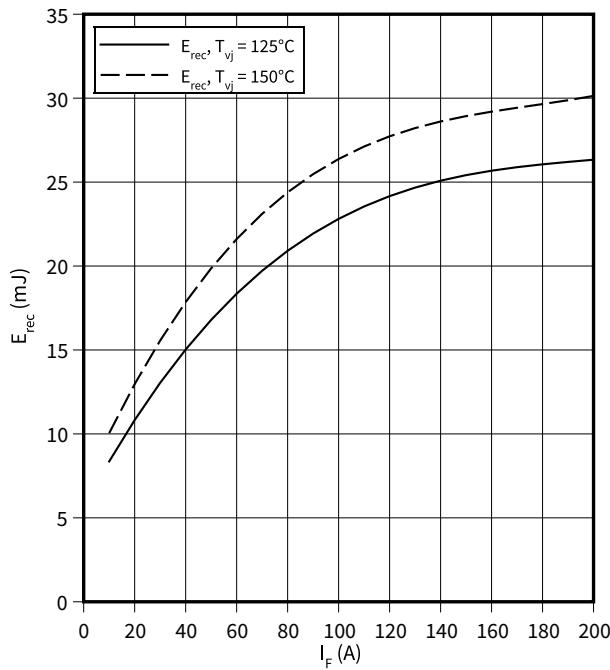
reverse bias safe operating area (RBSOA), IGBT, Inverter

$I_C = f(V_{CE})$
 $R_{Goff} = 0.91 \Omega$, $V_{GE} = \pm 15 \text{ V}$, $T_{vj} = 150^\circ\text{C}$



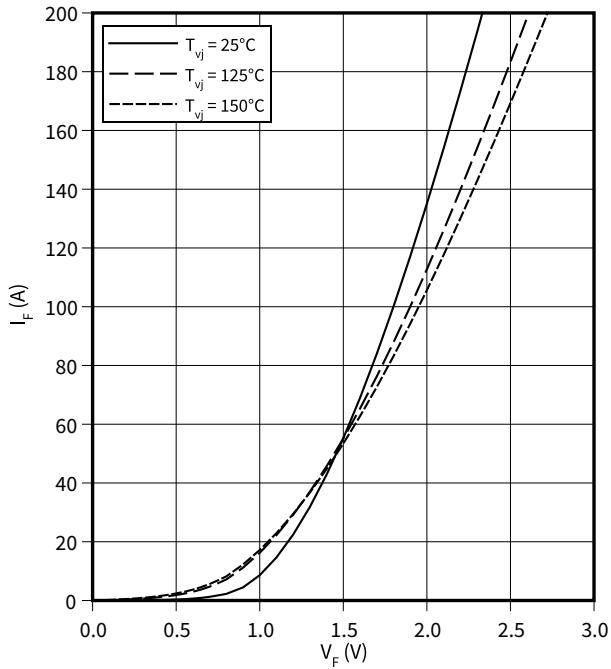
switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$
 $V_{CE} = 900 \text{ V}$, $R_{Gon} = R_{Gon}(\text{IGBT})$



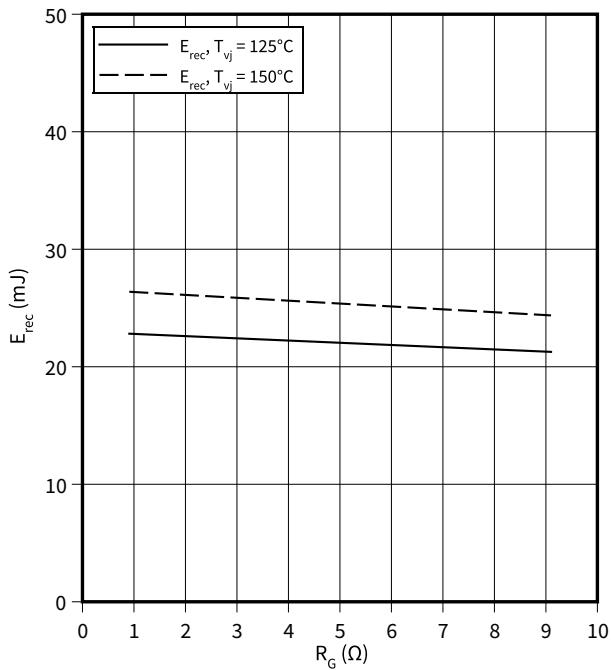
forward characteristic (typical), Diode, Inverter

$$I_F = f(V_F)$$



switching losses (typical), Diode, Inverter

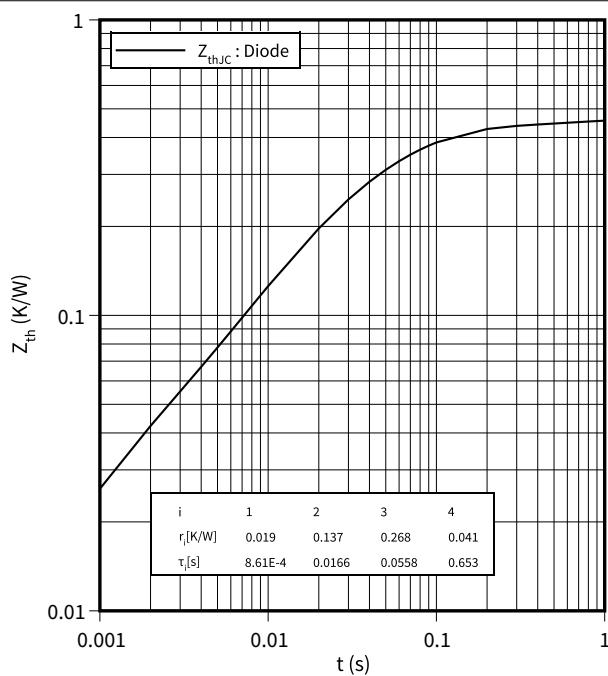
$E_{rec} = f(R_G)$
 $V_{CE} = 900 \text{ V}$, $I_F = 100 \text{ A}$



6 Characteristics diagrams

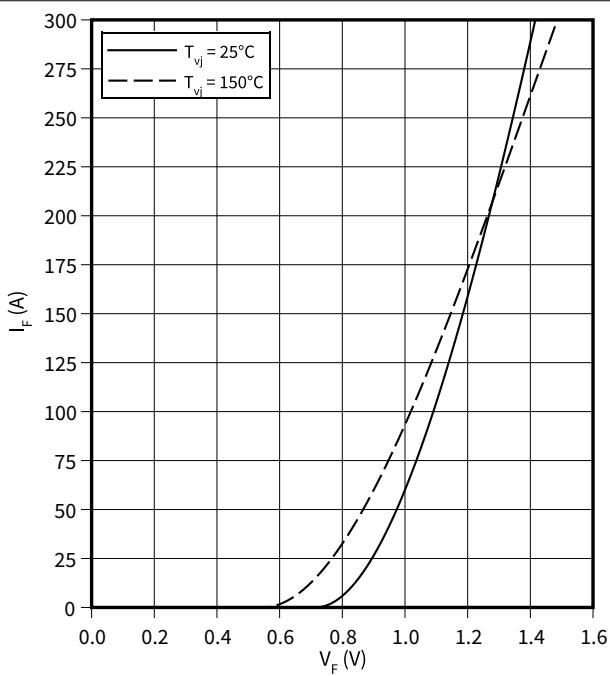
transient thermal impedance , Diode, Inverter

$$Z_{th} = f(t)$$



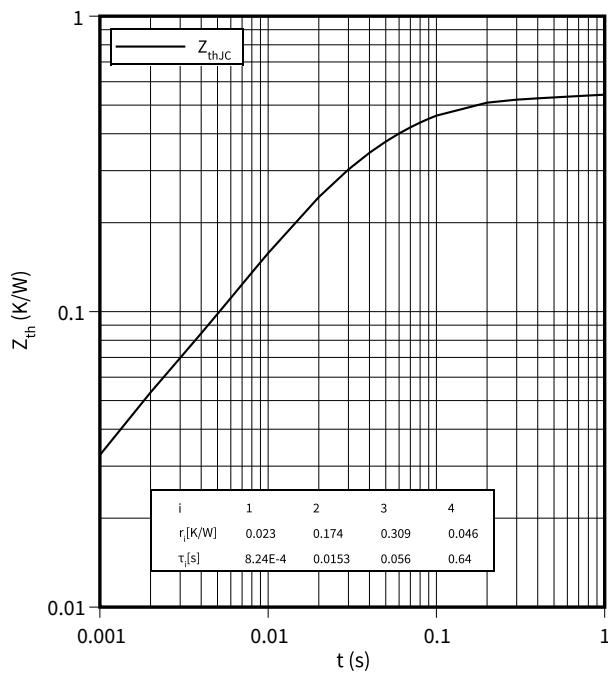
Forward characteristic (typical), Diode, Rectifier

$$I_F = f(V_F)$$



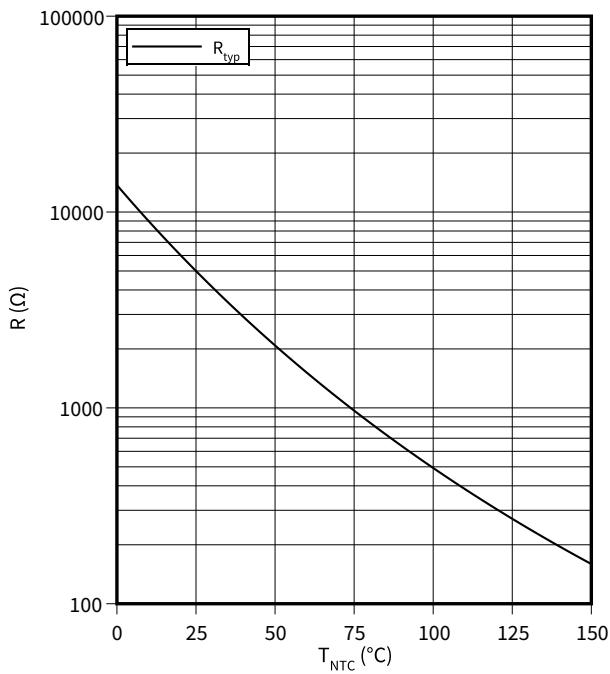
Transient thermal impedance, Diode, Rectifier

$$Z_{th} = f(t)$$



Temperature characteristic (typical), NTC-Thermistor

$$R = f(T_{NTC})$$



7 Circuit diagram

7 Circuit diagram

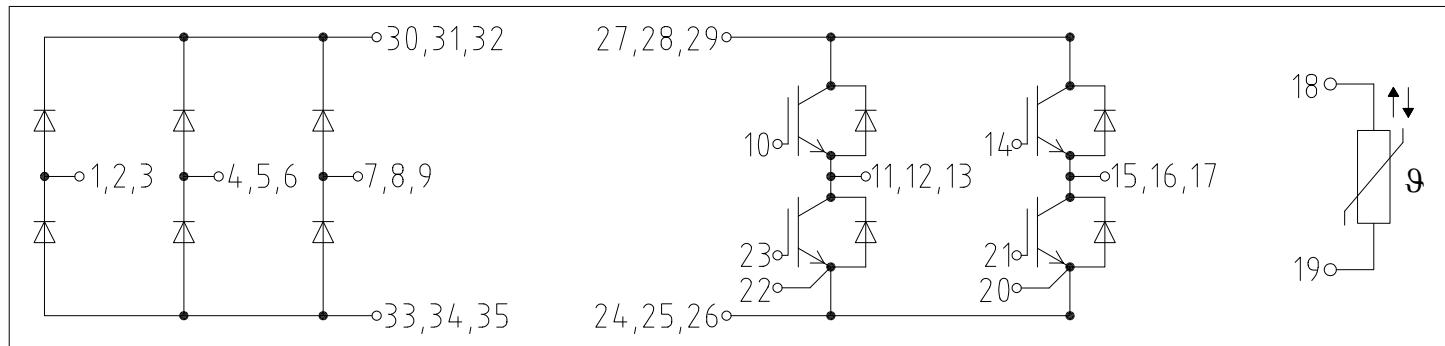


Figure 2

8 Package outlines

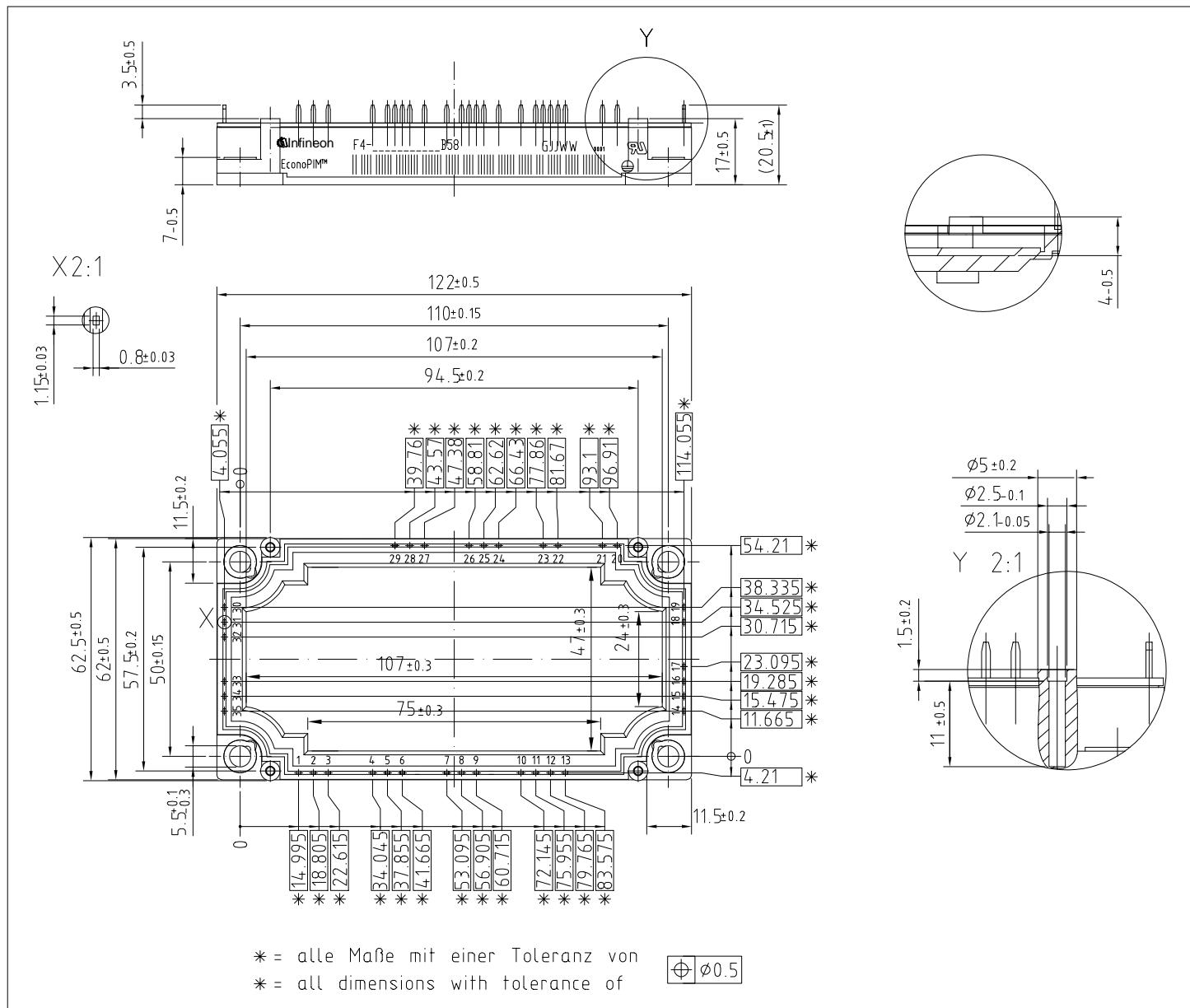


Figure 3

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Edition 2021-04-16

Published by

**Infineon Technologies AG
81726 Munich, Germany**

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